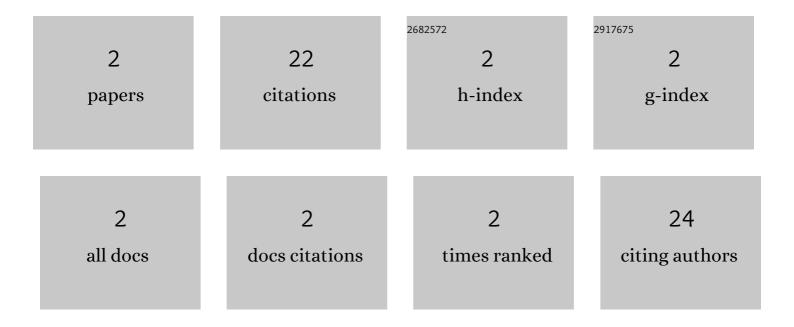
## Kenechi A Agbim

List of Publications by Year in descending order

Source: https://exaly.com/author-pdf/5972737/publications.pdf Version: 2024-02-01



#	Article	IF	CITATIONS
1	Integration of Jet Impingement Cooling With Direct Bonded Copper Substrates for Power Electronics Thermal Management. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2019, 9, 226-234.	2.5	11
2	Investigation of Thermoresponsive Microgel Polymer Swelling Theory. Polymer Reviews, 2020, 60, 648-670.	10.9	11